

Amendments to the Claims:

This listing of claims will replace all prior versions and listings of claims in the application.

Listing of Claims:

1. (Original) A light receiving module comprising: a light receiving element, an IC chip, a light permeable and electrically insulating sealing member for sealing the light receiving element and the IC chip, a lens provided at a surface of the sealing member facing the light receiving element, and a light impermeable and electroconductive coating for covering the sealing member with the lens exposed, the coating being connected to ground,

wherein the coating is provided with a vertical wall made up of an electroconductive member and surrounding the lens.

2. (Original) The light receiving module according to claim 1, wherein the lens is a convex lens,

wherein the vertical wall has a height greater than a height of the lens in a thickness direction of the lens.

3. (Original) The light receiving module according to claim 2, wherein the vertical wall includes an inner surface for reflecting light, the inner surface being inclined in a manner such that an inner diameter of the vertical wall is reduced as proceeding toward a bottom.

4. (Currently Amended) The light receiving module according to ~~any one of claim 1 to 3~~ claim 1, wherein the sealing member and the electroconductive member are made of resin.